L	Hits	Search Text	DB	Time stamp
Number	10	(430/323).ccls. and nano	USPAT;	2003/09/24
1	10	(430/323).CCIS. and hand	US-PGPUB; IBM TDB	20:49
	22	wiring adj substrate adj manufacturing	USPAT;	2003/09/19
_	22	adj method	US-PGPUB; IBM TDB	13:23
	1	(wiring adj substrate adj manufacturing	USPAT;	2003/09/19
~	1	adj method) and photomask	US-PGPUB; IBM TDB	13:24
_	1	(wiring adj substrate adj manufacturing	USPAT;	2003/09/19
	_	adj method) and photomask and nano	US-PGPUB; IBM TDB	13:25
_	0	photomask and (nano adj paricle)	USPAT;	2003/09/19
			US-PGPUB; IBM TDB	13:25
_	11	photomask and (nano adj particle)	USPAT;	2003/09/19
:			US-PGPUB; IBM TDB	13:25
-	10	("3680028" "4352835" "4407695"	USPAT	2003/09/22
		"4664748" "4835392" "5256587" "5382315" "5466627" "5656349"		16:42
	_	"5871870").PN.	HCDATT -	2002/00/22
_	1	photomask and (nano adj particle) and (black near (pigment or dye))	USPAT; US-PGPUB;	2003/09/22
_	1214	29/832.ccls.	IBM_TDB USPAT;	2003/09/22
_	1214	29/032.0015.	US-PGPUB; IBM TDB	17:05
_	3	29/832.ccls. and nano	USPAT;	2003/09/22
		23,032,00131 and hand	US-PGPUB; IBM TDB	19:37
1_	99	(toshihiko near tanaka).in.	USPAT;	2003/09/22
		(coonsist nous contains, can-	US-PGPUB; IBM TDB	17:48
_	1	(toshihiko near tanaka).in. and nano	USPAT;	2003/09/22
		,	US-PGPUB; IBM TDB	17:49
_	0	(toshihiko adj tanaka).in.	USPAT;	2003/09/22
			US-PGPUB; IBM TDB	17:50
_	99	(tanaka adj toshihiko).in.	USPAT;	2003/09/22
			US-PGPUB; IBM TDB	17:50
-	1	(tanaka adj toshihiko).in. and nano	USPAT;	2003/09/22
		-	US-PGPUB; IBM TDB	17:50
_	2	(kubo near masaharu).in. and nano	USPĀT;	2003/09/22
			US-PGPUB;	17:52
·			IBM_TDB	2002/00/22
-	1	(hattori near takashi).in. and nano	USPAT; US-PGPUB;	2003/09/22
	10	("3680028" "4352835" "4407695"	IBM_TDB USPAT	2003/09/22
_	10	("3680028" "4352835" "4407695" "4664748" "4835392" "5256587" "5382315" "5466627" "5656349"	USPAI	17:56
		"5871870").PN.		
_	2	6007969.URPN.	USPAT	2003/09/22
_	17	(wiring adj substrate) and (nano)	USPAT;	2003/09/22
			US-PGPUB;	18:23
	769	(wiring) and (nano)	IBM_TDB USPAT;	2003/09/22
-	/69	(WILING) and (Mano)	US-PGPUB;	18:58
			IBM_TDB	
-	15	(wiring) and (nano) and photomask	USPAT;	2003/09/22
			US-PGPUB;	18:23
1			IBM_TDB	

-	264	(wiring) and (nano) and mask	USPAT;	2003/09/22
			US-PGPUB;	18:58
	222	(windows) and (name) and mask and	IBM_TDB USPAT;	2003/09/22
_	222	(wiring) and (nano) and mask and substrate	US-PGPUB;	18:59
		supstrate	IBM TDB	10.33
	222	(method or process or step) and (wiring)	USPAT;	2003/09/22
	222	and (nano) and mask and substrate	US-PGPUB;	18:59
		and (name) and mash and sassifias	IBM TDB	
_	14	(method or process or step) and (wiring	USPAT;	2003/09/22
		near substrate) and (nano) and mask and	US-PGPUB;	18:59
		substrate	IBM_TDB	
-	10	("3680028" "4352835" "4407695"	USPAT	2003/09/22
		"4664748" "4835392" "5256587"		19:08
		"5382315" "5466627" "5656349"		·
		"5871870").PN.	IICDAM.	2003/09/22
-	2	29/846.ccls. and nano	USPAT; US-PGPUB;	19:37
			IBM TDB	19.37
_	2	29/847.ccls. and nano	USPAT;	2003/09/22
1		237 047. CCIS. and name	US-PGPUB;	19:39
			IBM TDB	
-	4	430/319.ccls. and nano	USPAT;	2003/09/24
			US-PGPUB;	11:53
			IBM_TDB	
-	23	(430/321,5).ccls. and nano	USPAT;	2003/09/24
			US-PGPUB;	12:42
		4854700708 852710478 854715508	IBM_TDB	2002/00/24
-	5	("5178978" "5371817" "5471552"	USPAT	2003/09/24
_	1924	"5550088" "5915051").PN. mask and nano	USPAT;	2003/09/24
-	1924	mask and hand	US-PGPUB;	12:43
			IBM TDB	12.13
_	1786	mask and nano and (conductive or	USPAT;	2003/09/24
		conductor or wire or wiring or trace or	US-PGPUB;	12:44
		track or line)	IBM_TDB	
_	198	(photomask or (photo adj mask)) and nano	USPAT;	2003/09/24
		and (conductive or conductor or wire or	US-PGPUB;	13:05
	1	wiring or trace or track or line)	IBM_TDB	2002/00/24
-	198	(method or process or step) and (photomask or (photo adj mask)) and nano	USPAT; US-PGPUB;	2003/09/24
		and (conductive or conductor or wire or	IBM TDB	14.03
		wiring or trace or track or line)	1511_105	
_	97	(method or process or step) with	USPAT;	2003/09/24
]		(photomask or (photo adj mask)) and nano	US-PGPUB;	13:06
		and (conductive or conductor or wire or	IBM_TDB	
		wiring or trace or track or line)		
-	2	(method or process or step) with	USPAT;	2003/09/24
		(photomask or (photo adj mask)) with nano	US-PGPUB;	13:05
		and (conductive or conductor or wire or wiring or trace or track or line)	IBM_TDB	
_	93	(method or process or step) with	USPAT;	2003/09/24
1 =	33	(photomask or (photo adj mask)) and nano	US-PGPUB;	13:14
		and (conductive or conductor or wire or	IBM TDB	
		wiring or trace or track or line) and	_	
		substrate		
-	10		USPAT;	2003/09/24
		(photomask or (photo adj mask)) and nano	US-PGPUB;	13:14
		with (conductive or conductor or wire or	IBM_TDB	
		wiring or trace or track or line) and		
_	22	substrate (method or process or step) and	USPAT;	2003/09/24
! -	23	(method or process of step) and (photomask or (photo adj mask)) and nano	US-PGPUB;	13:18
	1	and binder	IBM TDB	
-	1326		USPAT;	2003/09/24
		(photomask or (photo adj mask))	US-PGPUB;	13:19
			IBM_TDB	
-	1062	(method or process or step) near	USPAT;	2003/09/24
		(photomask)	US-PGPUB;	13:19
			IBM_TDB	

-	10	(method or process or step) near	USPAT;	2003/09/24
		(photomask) and nano	US-PGPUB;	13:20
			IBM_TDB	
-	130	(method or process or step) near (mask)	USPAT;	2003/09/24
		and nano	US-PGPUB;	13:21
			IBM_TDB	
-	4	(method or process or step) near (mask)	USPAT;	2003/09/24
		with nano	US-PGPUB;	13:26
			IBM_TDB	
-	38	(method or process or step) with (mask)	USPAT;	2003/09/24
		with nano	US-PGPUB;	13:26
			IBM_TDB	/ - /
-	1	(method or process or step) with (mask)	USPAT;	2003/09/24
		with nano with glass	US-PGPUB;	13:26
		(#0.600000 #4.250005# #4.407.605#	IBM_TDB	2002/00/24
-	10	("3680028" "4352835" "4407695"	USPAT	2003/09/24
		"4664748" "4835392" "5256587"		13:29
		"5382315" "5466627" "5656349"		
	•	"5871870").PN.	TIG D D M	2003/09/24
-	3	("4407695" "5510156" "5695658").PN.	USPAT	,,,
		F071070 HDDN	HCDAM	13:56 2003/09/24
-	12	5871870.URPN.	USPAT	14:00
	96044	(mothed or process or step) with (mas); or	USPAT;	2003/09/24
-	86044	<pre>(method or process or step) with (mask or photomask or (photo adj mask))</pre>	US-PGPUB;	14:04
		photomask of (photo adj mask))	IBM TDB	T3.02
_	38	(method or process or step) with (mask or	USPAT;	2003/09/24
-	30	photomask or (photo adj mask)) with nano	US-PGPUB;	14:11
		photomask of (photo adj mask), with hand	IBM TDB	11.11
_ '	3793	(method or process or step) with (mask or	USPAT;	2003/09/24
	3,75	photomask or (photo adj mask)) and	US-PGPUB;	14:12
		pigment	IBM TDB	
_	596	(method or process or step) with (mask or	USPAT;	2003/09/24
		photomask or (photo adj mask)) and (black	US-PGPUB;	14:12
		adj pigment)	IBM TDB	
_	22	(method or process or step) with (mask or	USPAT;	2003/09/24
		photomask or (photo adj mask)) with	US-PGPUB;	14:18
		(black adj pigment)	IBM TDB	
_	76	(mask or photomask or (photo adj mask))	USPAT;	2003/09/24
		with (black adj pigment)	US-PGPUB;	14:19
			IBM_TDB	
-	65	(mask or photomask or (photo adj mask))	USPAT;	2003/09/24
		with (black adj pigment) and glass	US-PGPUB;	14:19
			IBM_TDB	/ /
-	25	(mask or photomask or (photo adj mask))	USPAT;	2003/09/24
1		with (black adj pigment) with glass	US-PGPUB;	14:19
	_	("6410205")	IBM_TDB	2002/00/24
_	1	("6412305").PN.	USPAT;	2003/09/24
			US-PGPUB;	15:27
	,	/"5746677"\ DN	IBM_TDB USPAT;	2003/09/24
-	1	("5746677").PN.	US-PGPUB;	15:28
			IBM TDB	10.20
_	136	mask and pigment and glass and nano	USPAT;	2003/09/24
	130	maph and promote and grape and hand	US-PGPUB;	15:31
			IBM TDB	
_	117	mask and pigment and glass and nano and	USPAT;	2003/09/24
		(wire or wiring or track or lead or	US-PGPUB;	15:31
		conductor or trace)	IBM TDB	
-	117		USPAT;	2003/09/24
		pigment and glass and nano and (wire or	US-PGPUB;	15:32
		wiring or track or lead or conductor or	IBM_TDB	
		trace)		
_	4	1-1 <u>-</u>	USPAT;	2003/09/24
		(black adj pigment) and glass and nano	US-PGPUB;	15:48
		and (wire or wiring or track or lead or	IBM_TDB	
	1	conductor or trace or line or conductive)		
]	and layer		2002/00/24
-	3	4465749.URPN.	USPAT	2003/09/24
1	1			15:39

	1	mask with (black adj pigment) and glass	USPAT;	2003/09/24
-	1	and nano and (wire or wiring or track or	US-PGPUB;	15:48
		lead or conductor or trace or line or	IBM TDB	13.13
		conductive) and layer	12122	
	43	mask with (black adj pigment) and glass	USPAT;	2003/09/24
_	43	and (wire or wiring or track or lead or	US-PGPUB;	16:01
		conductor or trace or line or conductive)	IBM TDB	10.01
			1011_100	
	1	and layer	USPAT;	2003/09/24
-	1	mask with (black adj pigment) and glass	US-PGPUB;	16:01
		and (wire or wiring or track or lead or		10.01
		conductor or trace or line or conductive)	IBM_TDB	
		and layer and nano	***	2003/00/24
-	4	mask with (black adj pigment) and glass	USPAT;	2003/09/24
		and (wire or wiring or track or lead or	US-PGPUB;	16:01
		conductor or trace or line or conductive)	IBM_TDB	
		and layer and micro		2222/22/24
-	3660	photo adj etching	USPAT;	2003/09/24
			US-PGPUB;	17:18
			IBM_TDB	
-	24	(photo adj etching) with positive	USPAT;	2003/09/24
			US-PGPUB;	17:19
			IBM_TDB	
_	19	(photo adj etching) with positive and	USPAT;	2003/09/24
		negative	US-PGPUB;	18:32
			IBM_TDB	
_	12	(mask or photomask or (photo adj mask))	USPAT;	2003/09/24
		with (black adj pigment) with glass and	US-PGPUB;	17:54
	1	carbon	IBM_TDB	
_	1	carbon with (black adj pigment) with nano	USPAT;	2003/09/24
			US-PGPUB;	17:55
			IBM TDB	
-	7	carbon with (black adj pigment) with	USPAT;	2003/09/24
		meter	US-PGPUB;	17:56
			IBM TDB	
_	1	carbon with (black adj pigment) with	USPAT;	2003/09/24
	_	micro	US-PGPUB;	17:56
			IBM TDB	
_	12	carbon with (black adj pigment) with	USPAT;	2003/09/24
		micrometer	US-PGPUB;	17:57
			IBM TDB	
_	12	(photo adj etching) with positive and	USPAT;	2003/09/24
1	1	negative and mask	US-PGPUB;	18:32
		110ga of to arra maon	IBM TDB	